## JJMICROELECTRONICS

# 60V, 86A, 2.8mΩ N-channel Power SGT MOSFET JMSH0603PK

#### Features

- Excellent  $R_{\text{DS(ON)}}$  and Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant

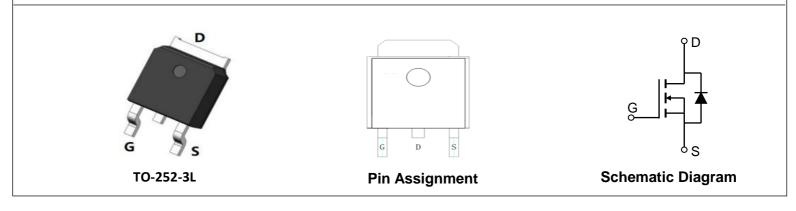
#### Applications

- Load Switch
- PWM Application
- Power Management

#### **Product Summary**

Parameters	Value	Unit
V <sub>DSS</sub>	60	V
V <sub>GS(th)_Typ</sub>	2.7	V
I <sub>D</sub> (@V <sub>GS</sub> =10V)	86	А
R <sub>DS(ON)_Typ</sub> (@V <sub>GS</sub> =10V	2.8	mΩ





#### **Ordering Information**

Device	Marking	MSL	Package	Reel(pcs)	Per Carton (pcs)
JMSH0603PK	SH0603P	3	TO-252-3L	2500	25000

#### Absolute Maximum Ratings (@ $T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Parameter		Unit
V <sub>DS</sub>	Drain-to-Source Voltage	Drain-to-Source Voltage		V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	$T_{C} = 25^{\circ}C$	86	Α
Ι <sub>D</sub>	Continuous Drain Current	$T_{\rm C} = 100^{\circ}{\rm C}$	61	~
I <sub>DM</sub>	Pulsed Drain Current <sup>(1)</sup>		Refer to Fig.4	А
E <sub>AS</sub>	Single Pulsed Avalanche Energ	ly <sup>(2)</sup>	330	mJ
P <sub>D</sub>	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	45	w
' D		$T_{c} = 100^{\circ}C$	18	VV
T <sub>J</sub> , T <sub>STG</sub>	Junction & Storage Temperature F	Junction & Storage Temperature Range		°C

#### **Thermal Characteristics**

Symbol	Parameter	Мах	Unit	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>	40	°C/M	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.8	°C/W	

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 48V, V_{GS} = 0V$	-	-	1.0	μΑ
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.9	2.7	3.5	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = 10V, I_D = 20A$	-	2.8	3.7	mΩ
Dynami	c Characteristics					
$R_g$	Gate Resistance	f = 1MHz	-	2.3	-	Ω
C <sub>iss</sub>	Input Capacitance		1779	2965	4003	pF
C <sub>oss</sub>	Output Capacitance	$V_{GS} = 0V, V_{DS} = 30V,$ f = 1MHz	981	1635	2207	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		42	71	95	pF
Qg	Total Gate Charge		27	45	61	nC
Q <sub>gs</sub>	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 20A$	-	14.4	19.5	nC
$Q_{gd}$	Gate Drain("Miller") Charge	VDS = 30 V, 10 = 207	-	10.5	14.1	nC
Switchi	ng Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime		-	14	-	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 30V	-	26	-	ns
t <sub>d(off)</sub>	Turn-Off DelayTime	$I_D = 20A, R_{GEN} = 3\Omega$	-	32	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	15	-	ns
Body D	iode Characteristics	-1		<u>.</u>	<u> </u>	<u>I</u>
I <sub>S</sub>	Maximum Continuous Body Diode Forward Current			-	86	Α
I <sub>SM</sub>	Maximum Pulsed Body Diode Forward Current		-	-	345	Α
$V_{\text{SD}}$	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time		-	52	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$ , di/dt = 100A/us	-	57	-	nC

#### **Electrical Characteristics** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

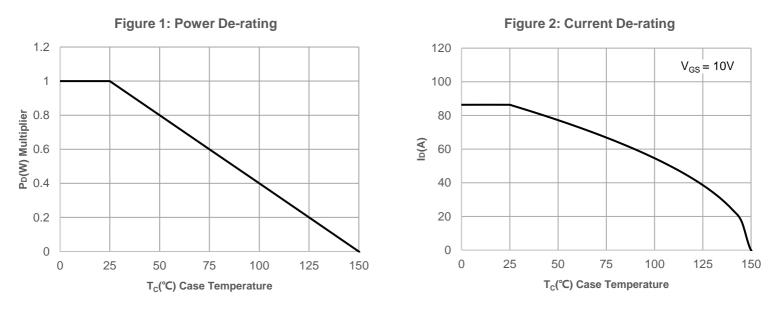
2.  $E_{AS}$  condition: Starting  $T_J$ =25C,  $V_{DD}$ =30V,  $V_G$ =10V,  $R_G$ =25ohm, L=3mH,  $I_{AS}$ =14.84A,  $V_{DD}$ =0V during time in avalanche.

3.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB.

4. Pulse Test: Pulse Width  ${\leqslant}300\mu s,$  Duty Cycle  ${\leqslant}0.5\%.$ 

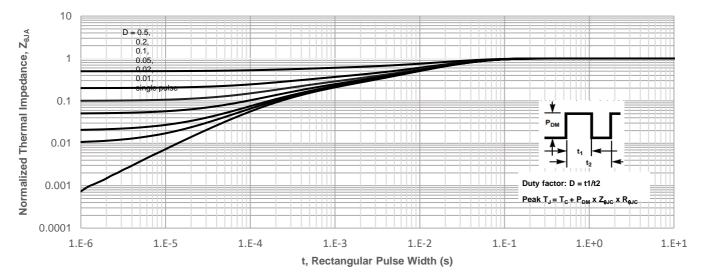




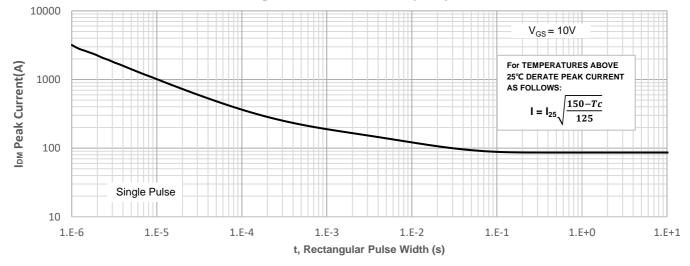


## **Typical Performance Characteristics**



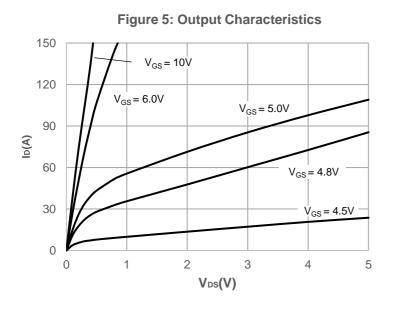






м





20  $V_{DS} = 5V$ 16 T<sub>J</sub> = 125°C 12 ID(A) T<sub>J</sub> = -55°C 8 4  $T_J = 25^{\circ}C$ 0 1 2 3 5 6 4 Vgs(V)

Figure 8: Body Diode Characteristics

100

10

1

0.1

0.01

0

0.2

Is(A)

 $V_{GS} = 0V$ 

 $T_J = 125^{\circ}C$ 

= 25°C

0.4

**Figure 6: Typical Transfer Characteristics** 

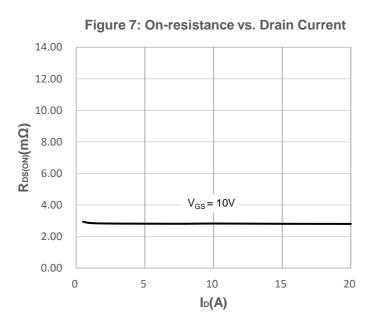


Figure 9: Gate Charge Characteristics

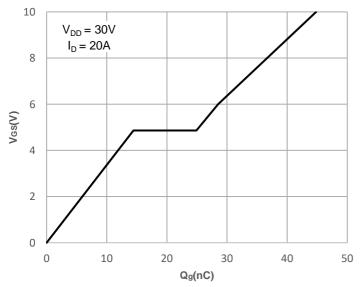


Figure 10: Capacitance Characteristics

0.8

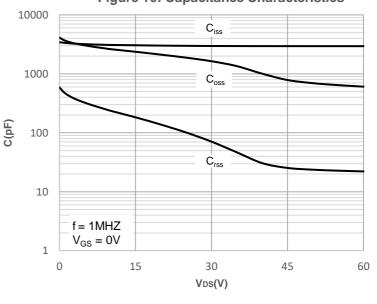
0.6

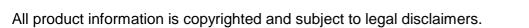
Vsd(V)

T<sub>J</sub> = -55°C

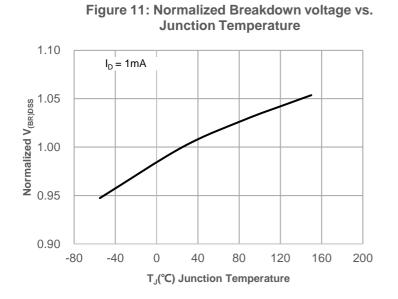
1

1.2

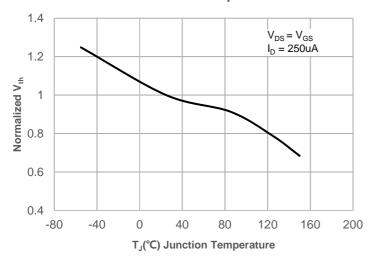


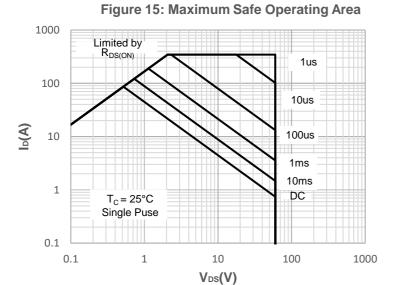


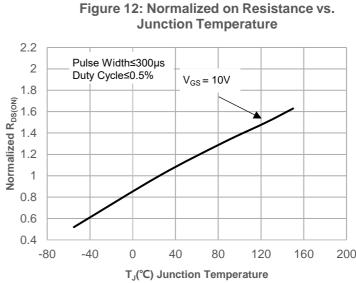
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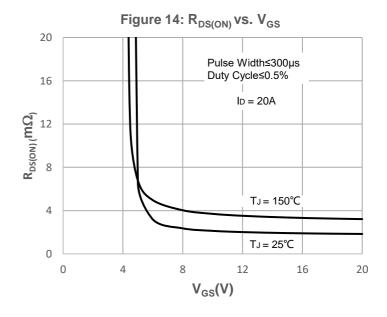


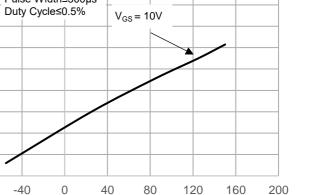














## **Test Circuit**

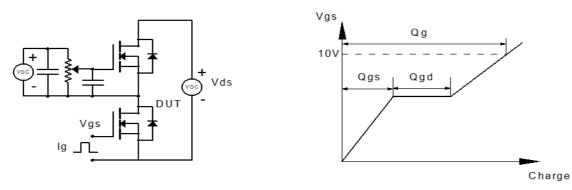


Figure 1: Gate Charge Test Circuit & Waveform

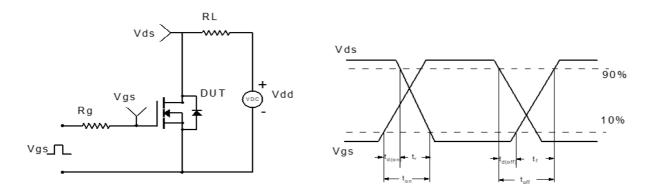


Figure 2: Resistive Switching Test Circuit & Waveform

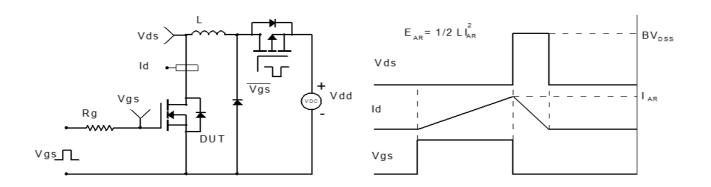


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

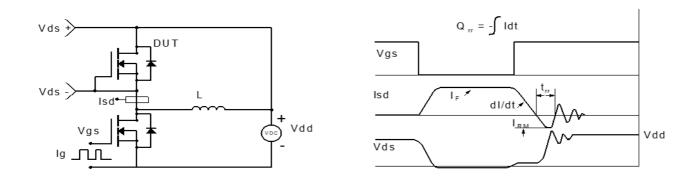
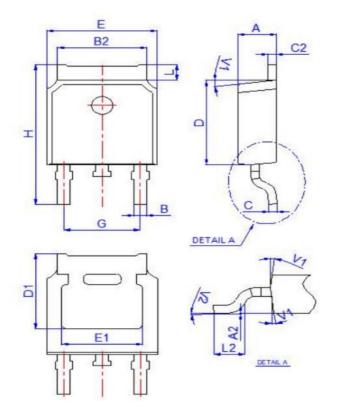


Figure 4: Diode Recovery Test Circuit & Waveform

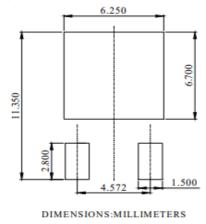


## Package Mechanical Data(TO-252-3L)



Ref.	Dimensions						
	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
A	2.10		2.50	0.083		0.098	
A2	0		0.10	0		0.004	
В	0.66		0.86	0.026		0.034	
B2	5.18		5.48	0.202		0.216	
С	0.40		0.60	0.016		0.024	
C2	0.44		0.58	0.017		0.023	
D	5.90		6.30	0.232		0.248	
D1	5.30REF			0	0.209REF		
E	6.40		6.80	0.252		0.268	
E1	4.63			0.182			
G	4.47		4.67	0.176		0.184	
Н	9.50		10.70	0.374		0.421	
L	1.09		1.21	0.043		0.048	
L2	1.35		1.65	0.053		0.065	
V1		7°			7°		
V2	0°		6°	0°		6°	

**Recommended Soldering Footprint** 



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